

Features

- Full-field Image Sensor 3500 x 2300 Pixels
- Pixel 10 μm x 10 μm Photo-MOS
- Image Zone: 35 mm x 23 mm
- Additional Full-frame Operating Mode: 2627 x 2300 pixels of 10 μm x 10 μm (3 zones)
- Frame Readout Through One, Two or Four Outputs
- Built-in Region of Interest (ROI) Selection
- Data Rates Up to 4 x 25 MHz (Compatibility with 10 Frames/Seconds)
- High Dynamic Range (Up to 3000), at Room Temperature and at 25 MHz Frequency
- Very Low Dark Current (MPP Mode)
- Bayer Standard Color Mosaic
- Flexibility and Performance Make Device Suitable for Digital Photography, Graphic Arts, Medical and Industrial Applications

Description

Atmel's AT71200M is a progressive scan sensor based on charge-coupled device (CCD) technology. It can be used in a wide range of applications thanks to operating mode flexibility, very high definition and high dynamic range.

The nominal photosensitive area is made up of 2300 x 3500 useful pixels and is split into four independent zones that are driven separately by four independent four-phase clocksets. Thus the sensor can be used in up to 12 main modes.

The large format and high definition make the device suitable for any application requiring precision and accuracy.

The Bayer standard RGB color mosaic has been specially designed for colorimetric applications and the three colors balanced for a 3800K standard illuminant.

Two serial registers and four independent output amplifiers offer a high-frequency functionality of up to 10 frames per second and a 12-bit dynamic range.



8M-pixel Color Image Sensor

AT71200M

Pinout

Figure 1. AT71200M Pinout – Top View

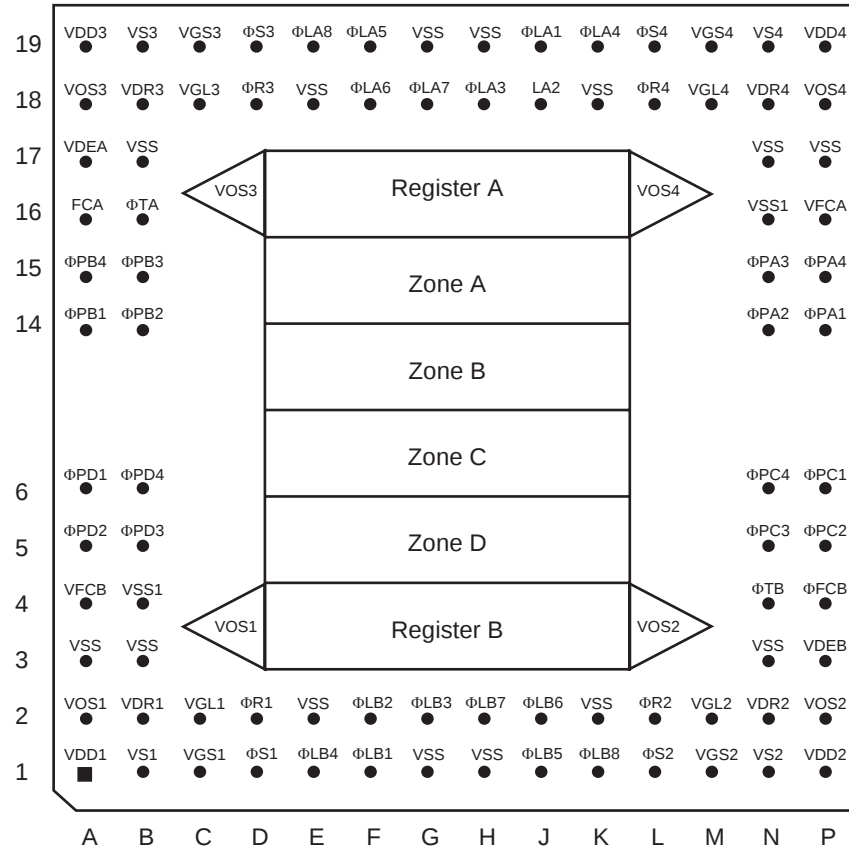
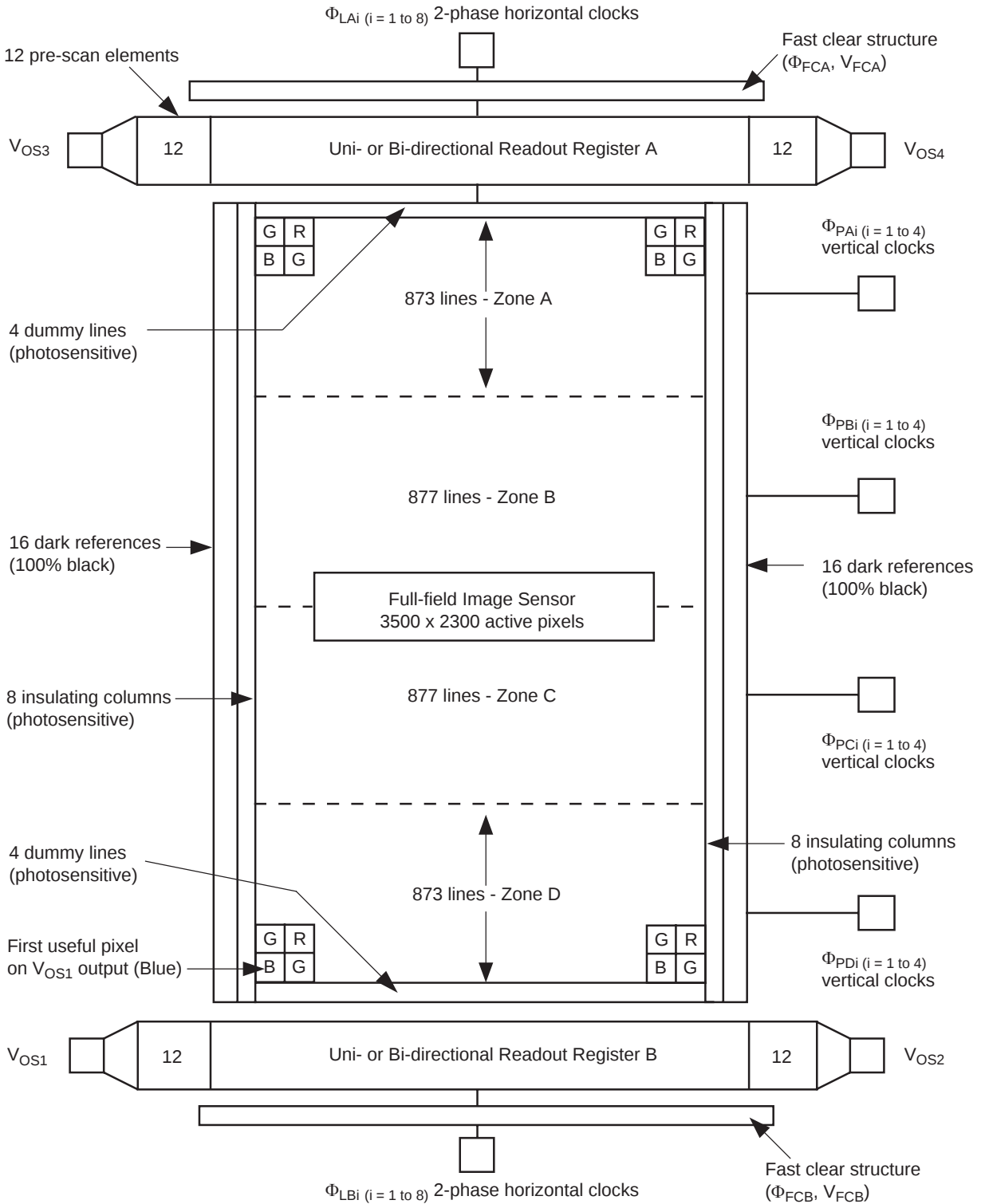


Table 1. AT71200M Pinout

Signal Name	Pin Number	Function
Φ LB[1:8]	F1, F2, G2, E1, J1, J2, H2, K1	B readout register clocks
Φ LA[1:8]	J19, J18, H18, K19, F19, F18, G18, E19	A readout register clocks
Φ S[1:4]	D1, L1, D19, L19	Summing clocks of the outputs 1, 2, 3 and 4
VGL[1:4]	C2, M2, C18, M18	Readout gate bias of the outputs 1, 2, 3 and 4
VGS[1:4]	C1, M1, C19, M19	Output gate bias of the outputs 1, 2, 3 and 4
VOS[1:4]	A2, P2, A18, P18	Output video signals 1, 2, 3 and 4
VDD[1:4]	A1, P1, A19, P19	Output amplifier drain supplies of the outputs 1, 2, 3 and 4
VS[1:4]	B1, N1, B19, N19	Output amplifier source biases of the outputs 1, 2, 3 and 4
Φ R[1:4]	D2, L2, D18, L18	Reset clocks of the outputs 1, 2, 3 and 4
VDR[1:4]	B2, N2, B18, N18	Reset bias of the outputs 1, 2, 3 and 4
Φ PA[1:4]	P14, N14, N15, P15	A image zone clocks
Φ PB[1:4]	A14, B14, B15, A15	B image zone clocks
Φ PC[1:4]	P6, P5, N5, N6	C image zone clocks
Φ PD[1:4]	A6, A5, B5, B6	D image zone clocks
Φ TA, Φ TB	B16, N4	Transfer gates from the image zone to the readout registers A and B respectively
VDEA, VDEB	A17, P3	Shield drains
VFCA, VFCEB	P16, A4	Region of interest drains
Φ FCA, Φ FCB	A16, P4	Region of interest clocks
VSS	A3, B3, B4, E2, G1, H1, K2, M3, B17, E18, G19, H19, K18, N16, N17, P17	Substrate bias

Block Diagram

Figure 2. AT71200M Block Diagram – Top View



Architectural Overview

General Parameters

Table 2. General Parameters

Parameters	Value
Pixel size	10 μm x 10 μm
Number of useful pixels on one line	2300
Number of useful lines	3500
Number of readout register	2
Number of outputs	4 ⁽¹⁾
MPP technology	yes
Region of interest structures on readout registers	yes
Built-in antiblooming	no
Pixel mode	4 phase
Readout register mode	2 phase

Note: 1. The design allows the full frame to be read through one, two or four outputs.

Vertical Characteristics – Top to Bottom AT71200M is made up of four zones, A, B, C and D. The configuration of each zone is shown in Table 3.

Table 3. Vertical Characteristics

Zone	Configuration
A	4 dummy photosensitive lines
	873 active lines, 100% photosensitive
B	877 active lines, 100% photosensitive
C	877 active lines, 100% photosensitive
D	873 active lines, 100% photosensitive
	4 dummy photosensitive lines

Horizontal Characteristics

Table 4 gives information on the characteristics seen by one output (V_{OS1} , V_{OS2} , V_{OS3} or V_{OS4}) in different readout modes.

Table 4. Horizontal Characteristics

Characteristic	Readout Mode	
	One Output	Two Outputs on Same Register
Pre-scan elements	12	12
Dark references	16	16
Insulating elements	8	8
Useful pixels	2300	1150

Color Mosaic Architecture

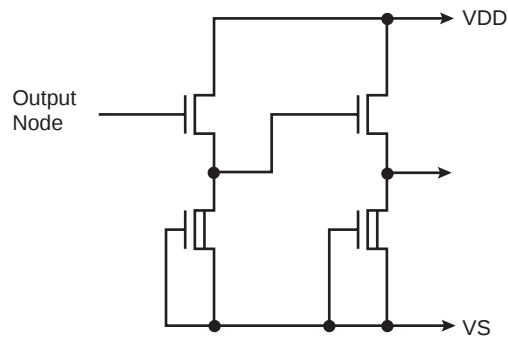
The color mosaic architecture corresponds to the Bayer standard represented by the following grid:

G	R	G	R
B	G	B	G
G	R	G	R
B	G	B	G

Output Amplifiers

The charge packets are clocked to the output nodes and the charges are converted to voltages. The potential at the output node is read through two stage source follower amplifiers. Refer to Figure 3.

Figure 3. On-chip Output Amplifier Structure



Absolute Maximum Ratings*

Storage Temperature Range	-55°C to +150°C
Operating Temperature Range.....	-40°C to +85°C
Thermal Cycling	15°C/mn

*NOTICE: Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Electrical limits of applied signals are given in Table 5.

Shorting the video output to V_{SS} or V_{DD} , even temporarily, can permanently damage the output amplifier.

Due to MPP mode or negative voltages, image zone gates and region of interest gates do not include ESD protection. To avoid degradation, the devices (including pins and package) should be handled with a grounded bracelet and stored on conductive layer used for shipment.

Table 5. Maximum Applied Voltages⁽¹⁾

Signal Name	Parameter	Min	Max	Unit
$\Phi LA[1:8]$	Readout A Register Clocks	-0.3	+15	V
$\Phi LB[1:8]$	Readout B Register Clocks	-0.3	+15	V
$\Phi S[1:4]$	Summing Gate	-0.3	+15	V
$VGL[1:4]$	Readout Gate	-0.3	+15	V
$VGS[1:4]$	Output Gate	-0.3	+15	V
$VOS[1:4]$	Output Video Signal	-0.3	+15	V
$VDD[1:4]$	Amplifier Drain Supply	-0.3	+15	V
$VS[1:4]$	Source Bias	-0.3	+15	V
$\Phi R[1:4]$	Reset Gate	-0.3	+15	V
$VDR[1:4]$	Reset Bias	-0.3	+15	V
$\Phi PA[1:4]$	Image Zone A Clocks	-15 and $\Phi PA[other] - 20$	+15 and $\Phi PA[other] + 20$	V
$\Phi PB[1:4]$	Image Zone B Clocks	-15 and $\Phi PB[other] - 20$	+15 and $\Phi PB[other] + 20$	V
$\Phi PC[1:4]$	Image Zone C Clocks	-15 and $\Phi PC[other] - 20$	+15 and $\Phi PC[1:4] + 20$	V
$\Phi PD[1:4]$	Image Zone D Clocks	-15 and $\Phi PD[other] - 20$	+15 and $\Phi PD[other] + 20$	V
ΦTA	Transfer Gates Zone A	$\Phi LA - 15$ and $\Phi PA[4] - 15$	+15 and $\Phi PA[4] + 15$	V
ΦTB	Transfer Gates Zone B	$\Phi LB - 15$ and $\Phi PD[4] - 15$	+15 and $\Phi PD[4] + 15$	V
$VDEA, VDEB$	Shield Drains	-0.3	+15	V
$VFCA, VFCEB$	Region Of Interest Drains	-0.3	+15	V
ΦFCA	Region Of Interest Gates Zone A	$\Phi LA[1:8] - 15$	+15	V
ΦFCB	Region Of Interest Gates Zone B	$\Phi LB[1:8] - 15$	+15	V
VSS	Substrate Bias		0	V

Note: 1. If not specified, all voltages are applied with respect to the substrate VSS .

DC Characteristics

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Typical Currents
$V_S^{(1)}$	Source bias	0	0	1	V	< 12 mA
$V_{DD}^{(1)}$	Amplifier drain supply	14.5	15	15.5	V	< 12 mA
V_{SS}	Substrate bias	0	0		V	–
V_{GS}	Output gate	7	7.5	8	V	< 1 μ A
V_{DR}	Reset diode	13.5	14	14.5	V	< 5 μ A
V_{GL}	Readout gate	3	3.5	4	V	< 1 μ A
V_{DE}	Shield drain	3	5	6	V	< 1 μ A
V_{FC}	Regions of interest drains	12.5	13	13.5	V	< 5 μ A

Note: 1. If corresponds to inactive output, may be stated to [3V, 7V] in order to reduce power consumption.

Drive Clock Characteristics

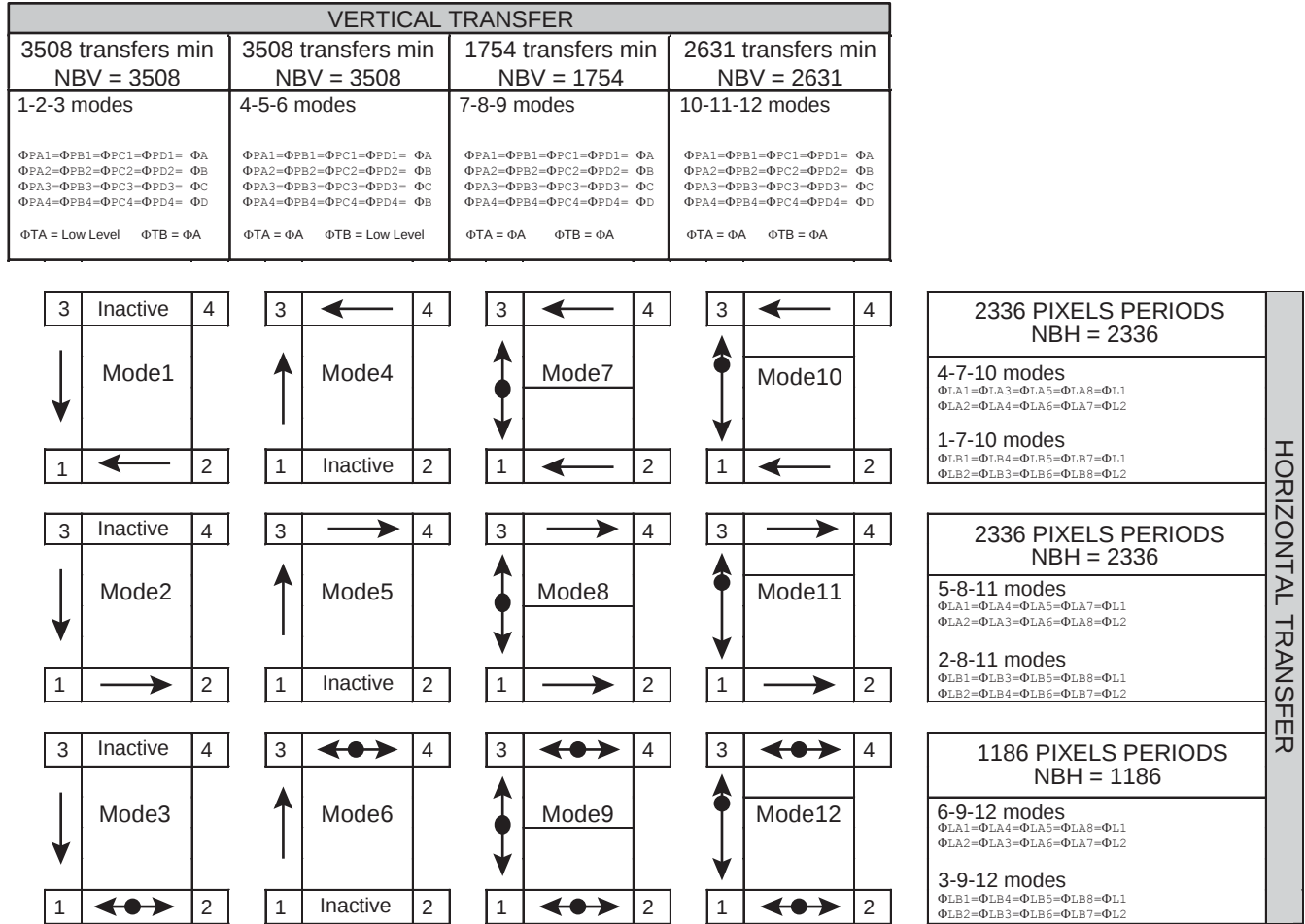
Symbol	Parameter	State	Minimum	Typical	Maximum	Unit	Remarks
$\Phi_{Pij}^{(1)(2)}$	Image Zone Clocks	Low	-10	-9	-8	V	For each A, B, C and D zone, the typical capacitances to drive are C_{Pij} approx. 12 nF
		High	+2.5	+3	+3.5	V	
$\Phi_{Lmn}^{(3)(4)}$	Readout Register Clocks	Low	0	0	+0.5	V	After the eight clocks have been grouped together to form the two clocks Φ_{L1} and Φ_{L2} , the typical capacitances to drive for each register A or B are $C_{\Phi L1}$ approx. 310 pF and $C_{\Phi L2}$ approx. 310 pF
		High	+7.5	+8	+9	V	
$\Phi_{Sj}^{(2)}$	Summing Gates	Low	0	0	+0.5	V	For each Φ_{Sj} , the typical capacitance to drive is $C_{\Phi Sj}$ approx. 40 pF
		High	+7.5	+8	+9	V	
$\Phi_{Rj}^{(2)}$	Reset Gates	Low	+1	+2	+3	V	For each Φ_{Rj} , the typical capacitance to drive is $C_{\Phi Rj}$ approx. 40 pF
		High	+8	+9	+10	V	
$\Phi_{Tm}^{(3)}$	Transfer Gates	Low	-6	-5	-4	V	For each Φ_{Tm} , the typical capacitance to drive is $C_{\Phi Tm}$ approx. 150 pF
		High	+2.5	+3	+3.5	V	
$\Phi_{FCm}^{(3)}$	Region of Interest Gates	FC inactive	-3.5	-2.5	-2	V	For each Φ_{FCm} , the typical capacitance to drive is $C_{\Phi FCm}$ approx. 50 pF
		Low	0	0	+0.5	V	
		High	+3.5	+4	+4.5	V	

- Notes:
1. $i = A, B, C$ or D
 2. $j = 1, 2, 3$ or 4
 3. $m = A$ or B
 4. $n = 1, 2, 3, 4, 5, 6, 7$ or 8

Operating Modes

For the required readout mode, the vertical and horizontal clocks must be tied together externally as shown in Figure 4.

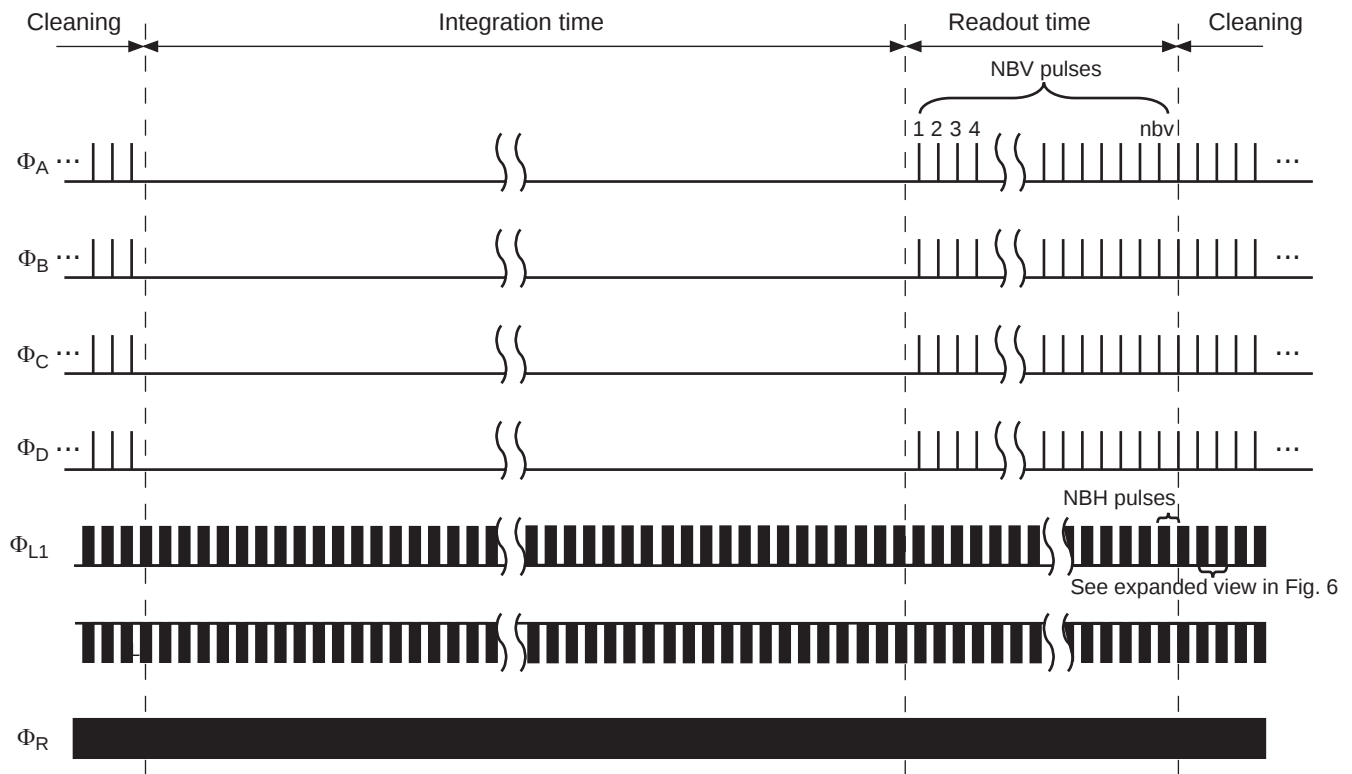
Figure 4. Operating Modes



Note: Symbols ΦA , ΦB , ΦC and ΦD correspond to the clocks described in the full-frame mode timing diagrams. Abbreviations NBV and NBH correspond respectively to the vertical and horizontal number of transfers. The unused horizontal clocks (ΦL , ΦR , ΦS) must be stated to higher level of ΦL .

Timing Diagrams

Figure 5. Full-frame Mode Timing Diagram



Note: Φ_A , Φ_B , Φ_C , Φ_D , Φ_{L1} and Φ_{L2} (command phases) and NBV and NBH (number of vertical transfers and number of horizontal transfers respectively) are defined in Figure 4.

Figure 6. Line Timing Diagram

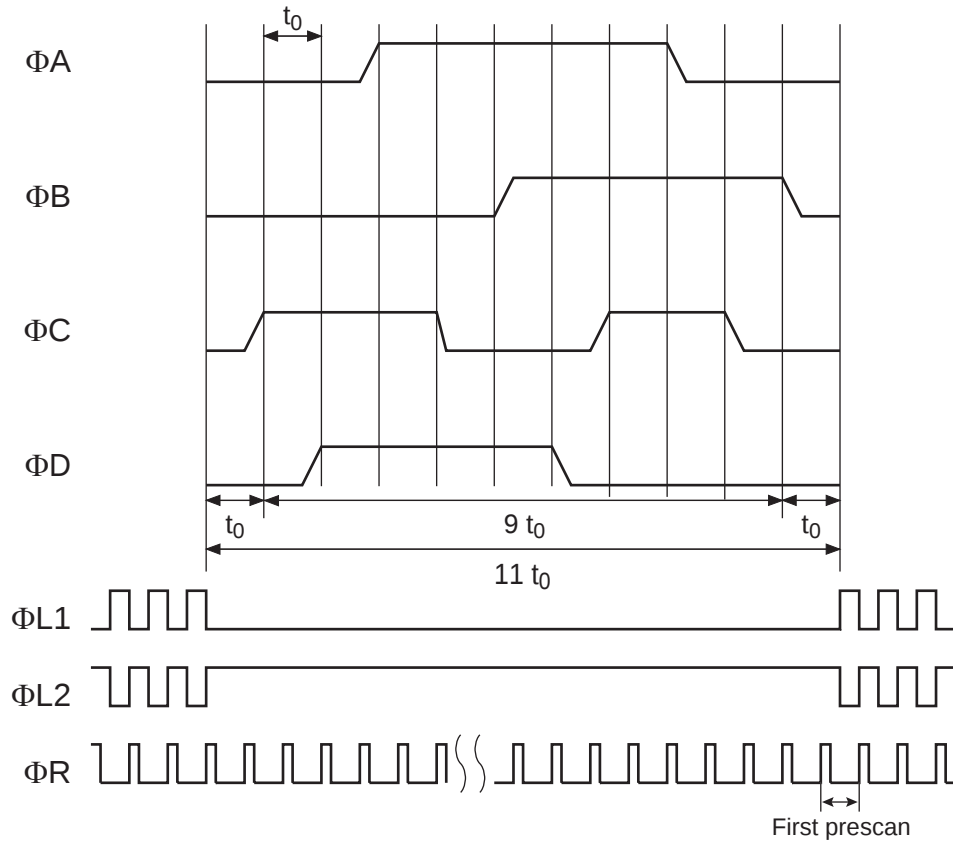
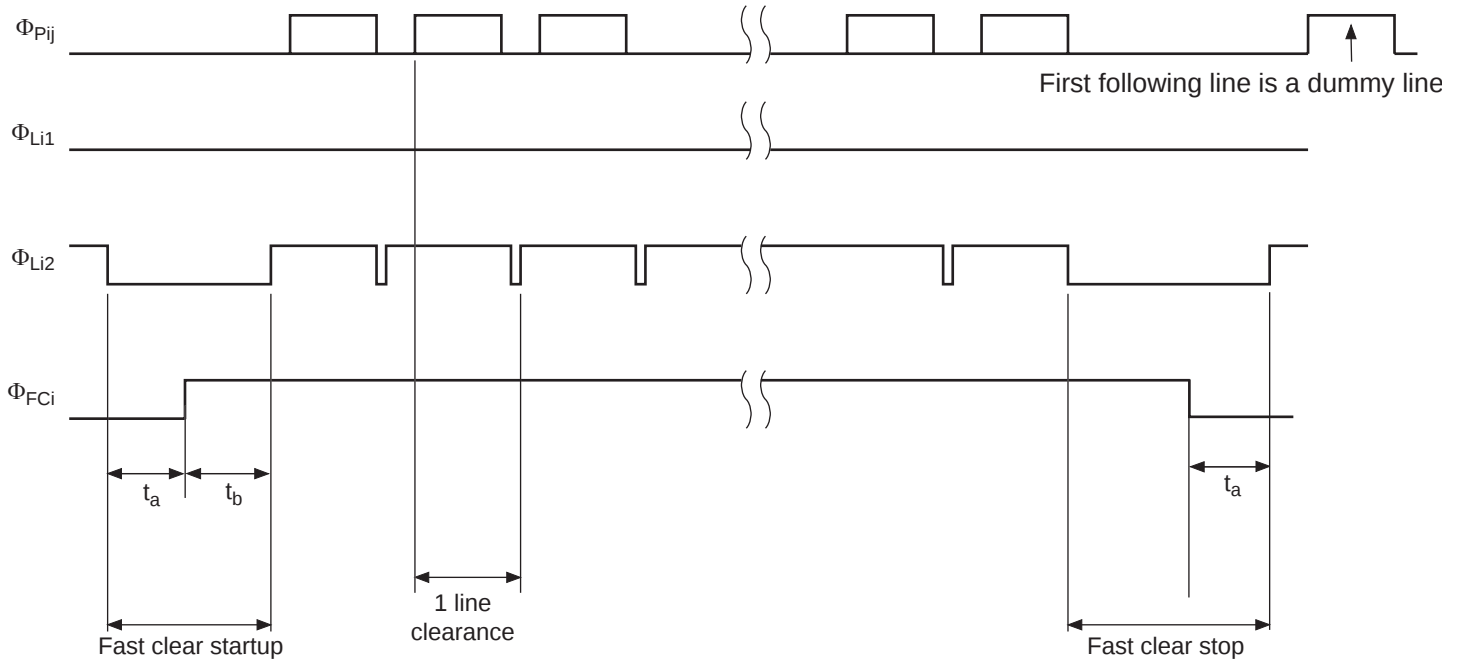


Figure 7. Region of Interest Operating Mode



Note: Typical values of t_a , t_b , t_c , t_d ≥ 150 ns, t_e ≥ 150 ns, t_f ≥ 150 ns

Table 6. Typical TR and TF (Time Rise, Time Fall) for Phases

Phase	Time
Φ_{P1}	500 ns
Φ_{P2}	500 ns
Φ_{P3}	500 ns
Φ_{P4}	500 ns
Φ_{FC}	50 ns
V_{FC}	50 ns
Φ_{L1}	10 ns
Φ_{L2}	10 ns
Φ_S	10 ns
Φ_R	4 ns

Frame Rate Characteristics

Table 7. Frame Rate Characteristics

	One Output (Modes 1, 2, 3, 4)	Two Outputs (Modes 13, 14)	Four Outputs (Mode 15)
Without binning	Typical 2.8 fps	Typical 5.1 fps	Typical 10.2 fps

Note: Table 7 gives typical values for full-frame mode where:

- Horizontal pixel frequency = 25 MHz
- Vertical transfer time $T_V = 11 \times t_0 = 10 \mu s$
(delay times before and after line transfer $t_1 = t_2 = t_0$)
- Integration time = 0s:

Table 8. Electrical and Miscellaneous Characteristics

Symbol	Parameters	Minimum	Typical	Maximum	Unit
V_{REF}	DC output level		10		V
Z_{OUT}	Output impedance		230		Ohms
$I_{DD}^{(1)}$	Output amplifier supply current		10	15	mA
C_{VF}	Charge-to-voltage conversion factor	7.3	7.6	8.0	$\mu V/e^-$
T_V	Vertical transfer time	5	10		μs
FH	Maximum Readout pixel frequency	25	–	–	MHz

Note: 1. For each output.

Electrooptical Data

Table 9. Performance Data⁽¹⁾

Symbol	Parameters	Minimum	Typical	Maximum	Unit
V_{SAT}	Pixel saturation output voltage	500	600	700	mV
R-Blue ⁽²⁾	Responsivity blue	0.45	0.60		V/(μ J/cm ²)
R-Green ⁽²⁾	Responsivity green	0.45	0.60		V/(μ J/cm ²)
R-Red ⁽²⁾	Responsivity red	0.70	0.92		V/(μ J/cm ²)
R-Blue ⁽²⁾	Responsivity blue		0.19		V/(lux.s)
R-Green ⁽²⁾	Responsivity green		0.19		V/(lux.s)
R-Red ⁽²⁾	Responsivity red		0.25		V/(lux.s)
PRNU	Photo response non uniformity, σ		1	6	% VOS
DSI1	Image zone MPP mode		0.3		mV/s
DSI2	Image zone non-MPP mode		60		mV/s
DSR	Readout register (non-MPP mode)		150		mV/s
VDS ⁽³⁾	Average dark signal		7	20	mV
DSNU ⁽³⁾	Dark signal non-uniformity, σ		3.5	5.5	mV
V_N	Temporal RMS noise in darkness at BW = 150 MHz		270		μ V
DR	Dynamic range		67		dB
	Linearity		1		%
MTF ⁽⁴⁾	Modulated transfer function		86		%
VCTE ⁽⁵⁾	Vertical charge transfer efficiency (per stage)	0.99995	0.999998		—
HCTE ⁽⁵⁾	Horizontal charge transfer efficiency (per stage)	0.99995	0.999998		—

- Notes:
- General measurement conditions:
 $T_C = 25^\circ\text{C}$ (chip temperature)
 Vertical transfer time $T_V = 10$ ms
 Readout pixel frequency $F_H = 5$ MHz
 Readout through 4 outputs and standard mode 9 (see figure 4)
 3200K Halogen lamp with 2 mm BG38 filter at f/11 aperture
 - Blue, Green, Red channels
 The responsivity are well balanced for 3800K source
 - Integration time $T_i = 10$ s in darkness
 - Green
 - Output voltage > 10% V_{SAT}

Figure 8. Typical Spectral Response with BG38 Infrared Filter (2 mm thickness), light source powered between 400 and 700 nm

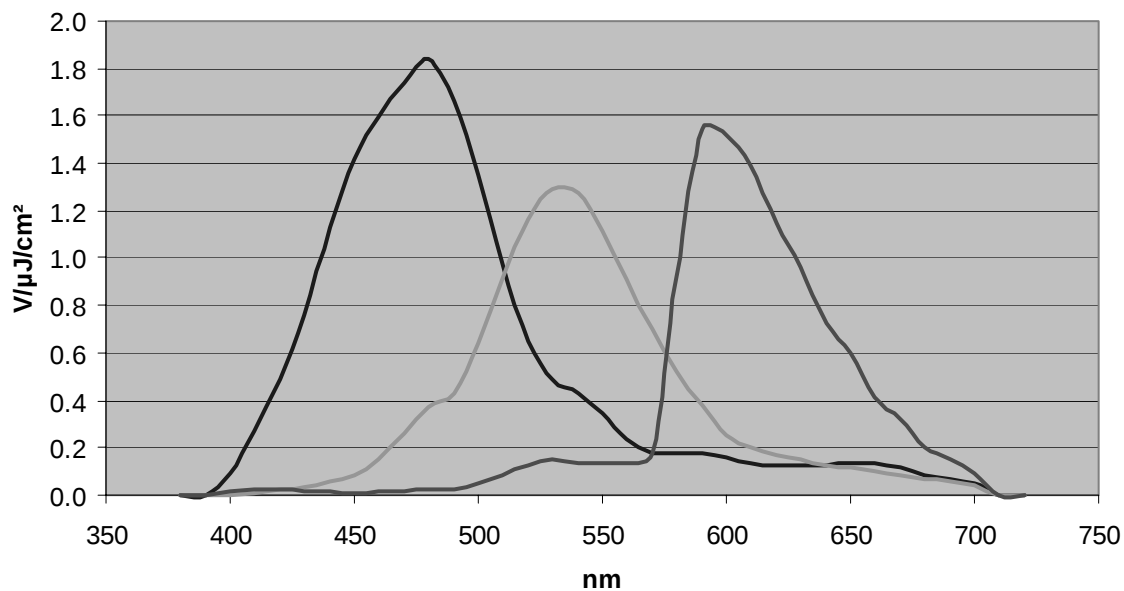


Image Grade

Table 10 gives results of image grade testing.

Table 10. Image Grade⁽¹⁾

Grade	Blemishes		Cluster 1		Cluster 2		Column	
	Total	D min ⁽²⁾	Total	D min ⁽²⁾	Total	D min ⁽²⁾	Total	D min ⁽²⁾
E	≤ 500	3	≤ 30	50	≤ 6	100	≤ 4	150
H	≤ 300	3	≤ 10	50	0		0	

- Notes:
- Testing has been carried out under the following conditions:
 Operating temperature: 25°C (unless otherwise specified)
 Illumination conditions: 3200K Halogen lamp with BG38 Infrared filter and f/11 aperture
 Integration time = 10s in darkness
 Test under illumination at 50% of saturation level
 Standard mode, $T_V = 10 \mu\text{s}$, FH = 5 MHz
 - D min: Minimum number of pixels separating defects in any direction. All occurrences are non-contiguous.

Definitions

Defect Sizes

Type	Description
Blemish	1 x 1 defect
Cluster	Blemish grouping of not more than a given number of adjacent defects: $1 \times 1 < \text{cluster 1 size} \leq 2 \times 2$ $2 \times 2 < \text{cluster 2 size} \leq 5 \times 5$
Column	One-pixel-wide column with more than seven contiguous defective pixels

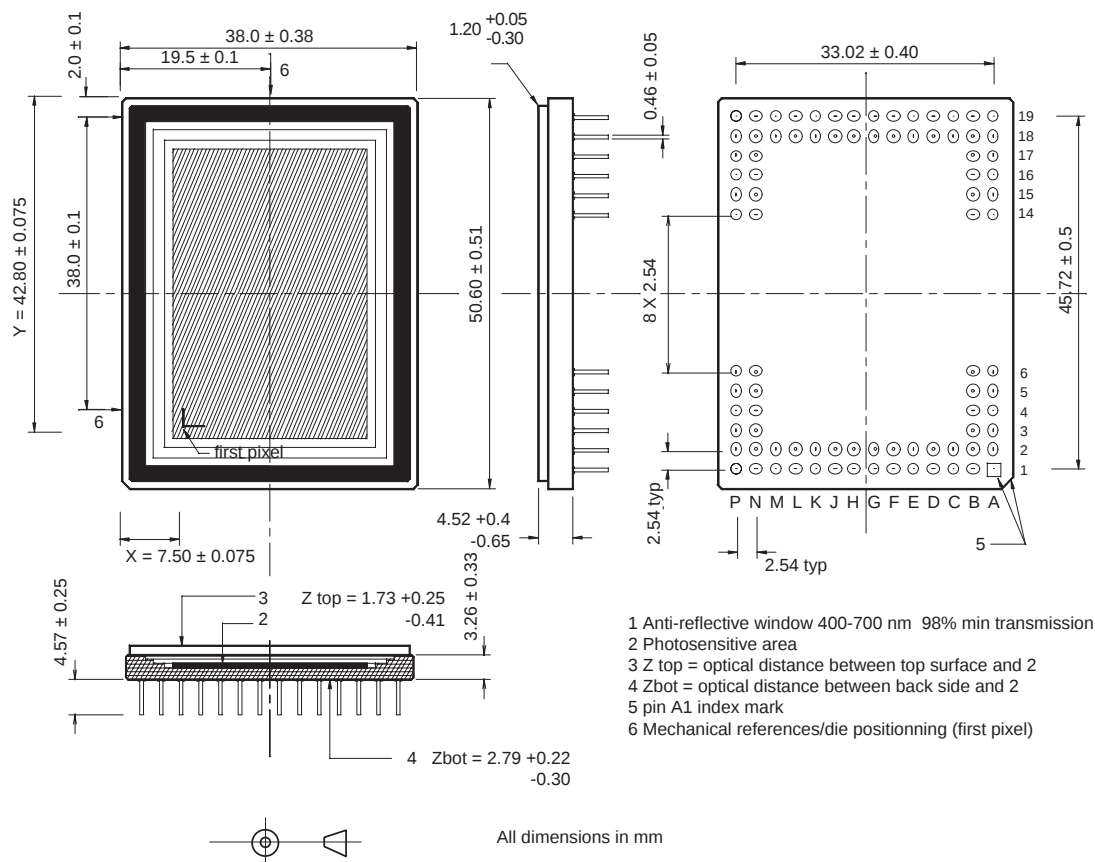
Defects in Darkness

Type	Description
Blemish/Cluster	Pixel signal deviation of more than 200 mV from the average output signal
Column	Column signal deviation of more than 20 mV from the average output signal

Defects under Illumination

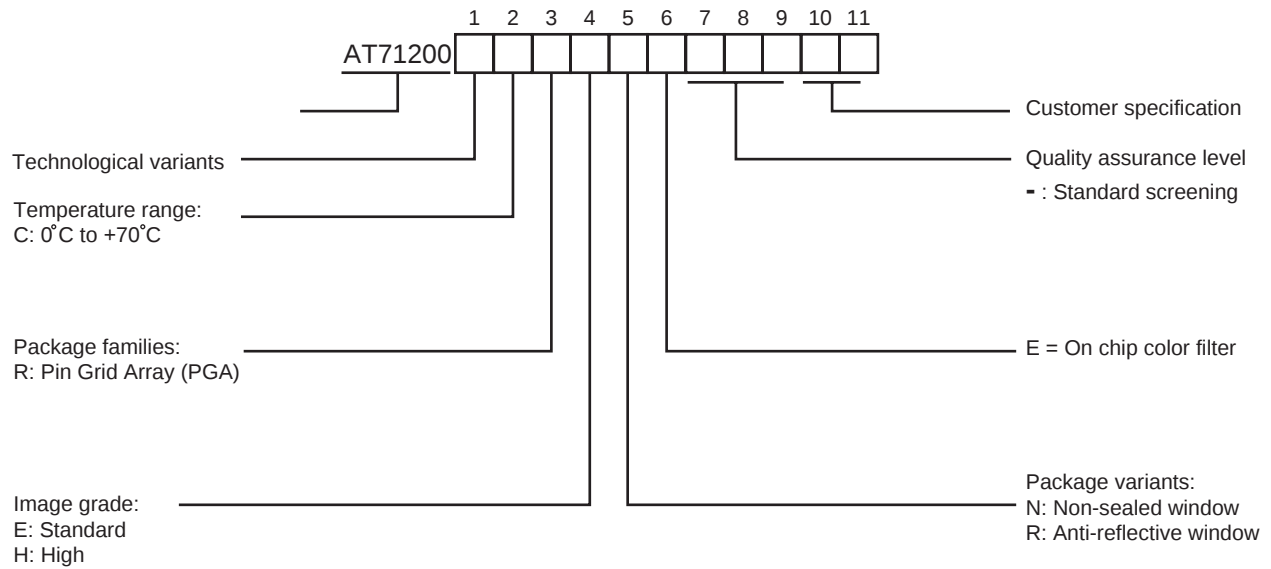
Type	Description
Blemish/Cluster	Pixel deviation of more than +20% or -30% from the average output signal
Column	Column deviation of more than 10% from the average output signal

Package Drawing



Ordering Information

Figure 9. Ordering Code Key



The following part numbers are available:

- AT71200MCRERE: version grade E
- AT71200MCRHRE: version grade H



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